Electronic Pate	ent App	lication Fee	Transm	ittal			
Application Number:	10	10581395					
Filing Date:	14-	14-Aug-2008					
Title of Invention:	Ch	Chip Scale Package and Method of Assembling the Same					
First Named Inventor/Applicant Name:	Hie	Hien Boon Tan					
Filer:	Car	Carl Joseph Pellegrini/ruth swanson					
Attorney Docket Number:	Q7	Q78657					
Filed as Large Entity	•						
U.S. National Stage under 35 USC 371 Fi	ling Fee	s					
Description		Fee Code	Quantity	Amount	Sub-Total ir USD(\$)		
Basic Filing:				1			
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	130	130		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			130